

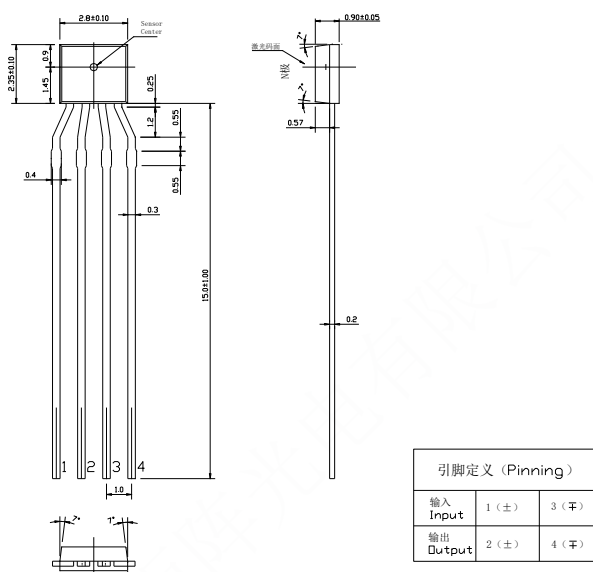
SL-322B InSb Hall Element

Ultra High-sensitivity InSb Hall element

Thin-type SIP Package

Shipped in Bulk by Pack (500Pcs devices per pack)

Dimensional Drawing (Unit: mm)



Absolute Maximum Rating

Operating Temperature Range	-40°C ~ 110°C
Storage Temperature Range	-40°C ~ 125°C
Maximum Input Current I_{cmax}	20mA
Maximum Input Voltage V_{cmax}	2V

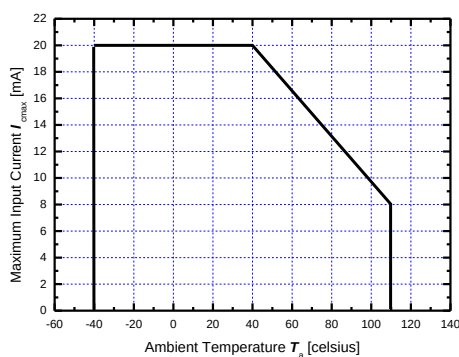


Figure 1.1 Maximum Input Current I_{cmax}

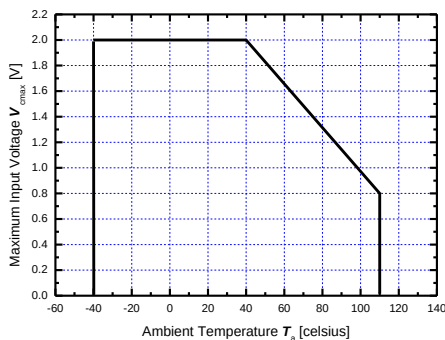


Figure 1. 2 Maximum Input Voltage V_{cmax}

Electrical Characteristics (RT=25°C)

Table 1. Electrical Characteristics of MW921.

Item	Symbol	Test Condi.	Min.	Typ.	Max.	Unit
Hall Voltage	V_H	$B = 50mT, V_C = 1V$ $T_a = RT$	168		320	mV
Input Resistance	R_{in}	$B = 0mT, I_C = 0.1mA$ $T_a = RT$	240		550	Ω
Output Resistance	R_{out}	$B = 0mT, I_C = 0.1mA$ $T_a = RT$	240		550	Ω
Offset Voltage	V_{os}	$B = 0mT, V_C = 1V$ $T_a = RT$	-7		+7	mV
Temp. Coeffi. of V_H	αV_H	$B = 50mT, I_C = 5mA,$ $T_a = 0^\circ C \sim 40^\circ C$		-1.8		%/ $^\circ C$
Temp. Coeffi. of R_{in}	αR_{in}	$B = 0mT, I_C = 0.1mA,$ $T_a = 0^\circ C \sim 40^\circ C$		-1.8		%/ $^\circ C$

Note:

1. $V_H = V_{H-M} - V_{os}$

In which V_{H-M} is the Output Hall Voltage, V_H is the Hall Voltage and V_{os} is the offset Voltage under the identical electrical stimuli.

2. $\alpha V_H = \frac{1}{V_H(T_1)} \times \frac{V_H(T_3) - V_H(T_2)}{(T_3 - T_2)} \times 100$

3. $\alpha R_{in} = \frac{1}{R_{in}(T_1)} \times \frac{R_{in}(T_3) - R_{in}(T_2)}{(T_3 - T_2)} \times 100$

$T_1 = 20^\circ C, \quad T_2 = 0^\circ C, \quad T_3 = 40^\circ C$

Classification of Output Hall Voltage (V_H)

Table 2. Classification of Hall Voltage

Rank	V_H [mV]	Conditions
C	168 ~ 204	B=50mT, $V_C=1V$
D	196 ~ 236	
E	228 ~ 274	
F	266 ~ 320	

Characteristic Curves

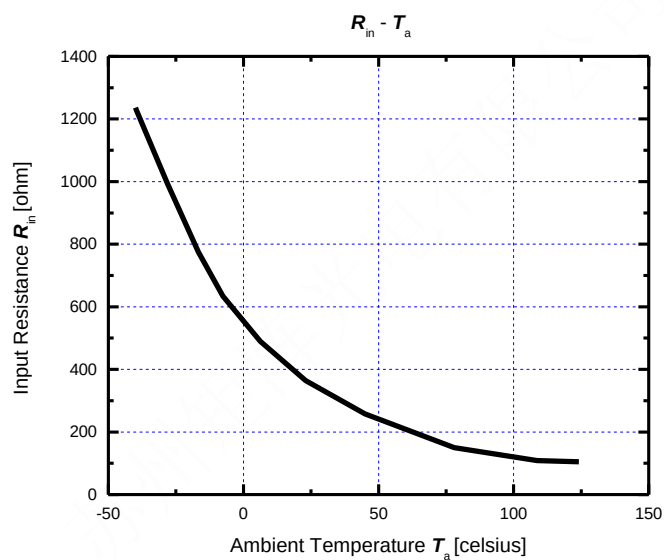


Figure 2. Input resistance R_{in} as a function of ambient temperature T_a .

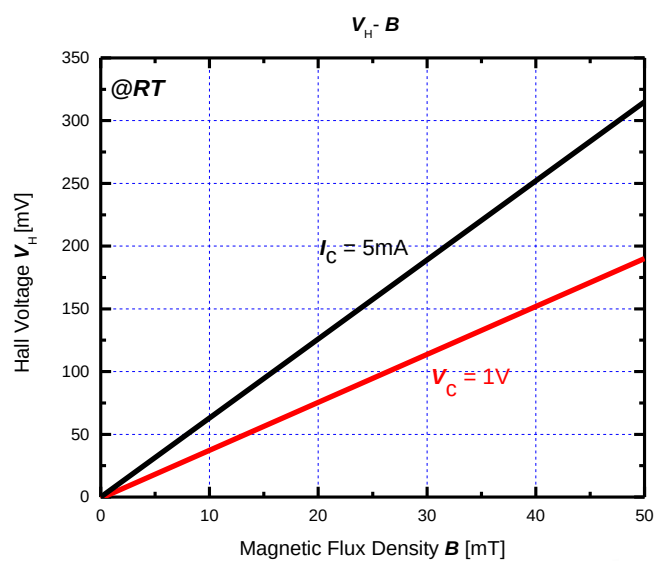


Figure 3. Hall voltage V_H as a function of magnetic flux density B .

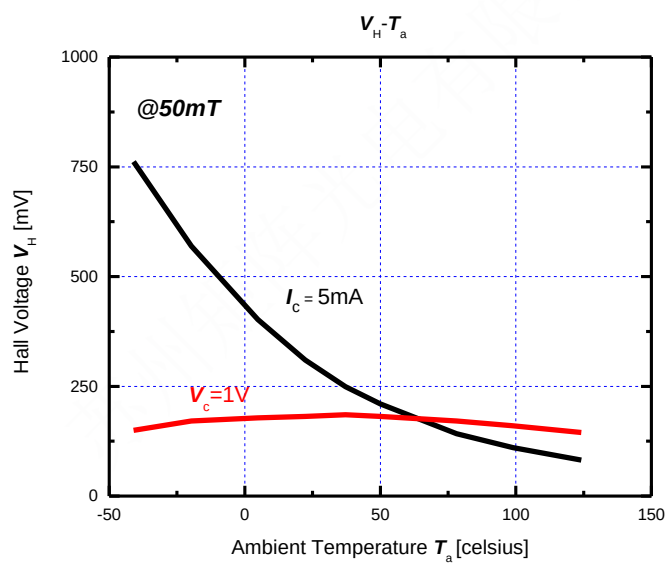


Figure 4. Hall voltage V_H as a function of ambient temperature T_a .

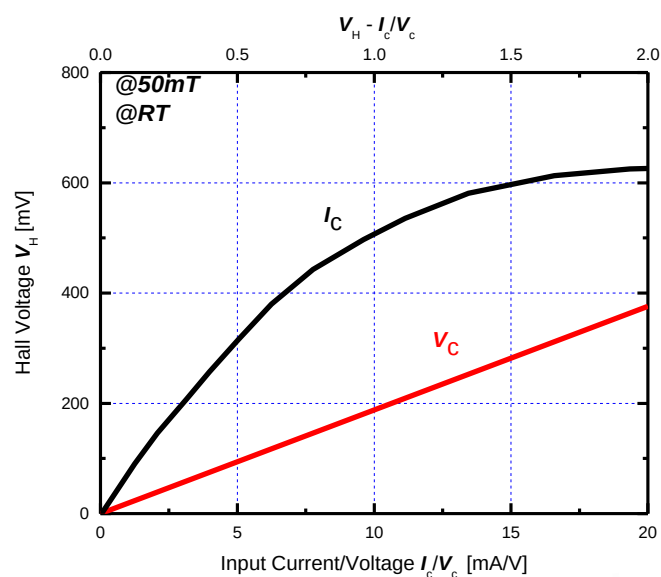


Figure 5. Hall voltage V_H as a function of electrical stimuli I_c/V_c .

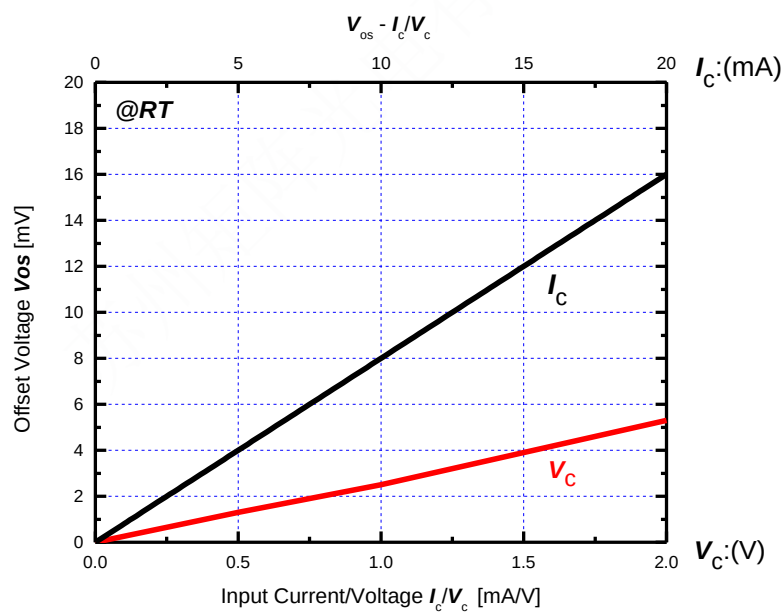


Figure 6. Offset voltage V_{os} as a function of electrical stimuli I_c/V_c .

Reliability Test Terms

Table 2. Reliability Test Terms, Conditions and Duration.

No.	Terms	Conditions	Duration
1	High Temperature Storage (HTS)	【JEITA EIAJ ED-4701】 $T_a = 150$ (0 ~ +10) °C	1000 hrs
2	Heat Cycle (HC)	【JEITA EIAJ ED-4701】 $T_a = -55^{\circ}\text{C} \sim 150^{\circ}\text{C}$ high temp. - normal temp. - low temp. 30 min - 5 min - 30 min	30 cycles
3	Temp. Humidity Storage (THS)	【JEITA EIAJ ED-4701】 $T_a = 85 \pm 3^{\circ}\text{C}$, $R_H = 85 \pm 5\%$	1000 hrs
4	Resist. to Hand Soldering Heat (RHS)	【JEITA EIAJ ED-4701】 Dipped in the $300 \pm 5^{\circ}\text{C}$ solder up to the 1 mm part from the body	5 sec
5	High Temp. Operating (HTO)	$T_a = 120^{\circ}\text{C}$, $V_c = 1\text{V}$	1000 hrs

Criteria:

- Variation of Hall Voltage V_H and input/output resistances $R_{in/out}$ are less than 20%.
- Variation of offset voltage V_{os} is less than $\pm 16\text{mV}$.
- Other parameters in **Table 1.** are still within their ranges stated in **Table 1.**

Soldering Conditions

The following conditions should be preserved. Solder ability should be checked by yourself, because it is depend on solder paste material and other parameters.

Material of solder flux

- Use the resin based flux and refrain from using organic or inorganic acid based and water-soluble one.

Cleansing of solder flux conditions

- Use Ethanol or Isopropyl alcohol as cleansing material.
- Process temperature should be 50 °C or less.
- Duration should be 5 minutes or less.

Hand soldering conditions

- Apart from the mold resin more than 1mm.
- Solder at temperature 300 °C for less than 5s.

Wave soldering conditions

- Temperature in Pre-heating zone should be lower than 150°C.
- Temperature in Soldering zone should be lower than 280°C.

Precautions for ESD

This product is the device that is sensitive to ESD (Electrostatic Discharge). Handling Hall Elements with the ESD-Caution mark under the environment in which

- Static electrical charge is unlikely to arise (Ex: Relative Humidity over 40%RH).
- Wearing the anti-static suit and wristband when handling the devices.
- Implementing measures against ESD as for containers that directly touch the devices.

Precautions for Storage

- Products should be stored at an appropriate temperature and humidity (5°C to 35°C, 40%RH to 60%RH) after the unsealing of the MBB. Keeping products away from chlorine and corrosive gas.
- **For storage longer than 2 years**

Products are sealed in MBB with a desiccant. It is recommended to store in nitrogen atmosphere with MBB sealed. Oxygen and H₂O of atmosphere oxidizes leads of products and lead solder ability get worse.

Precautions for Safety

- Do not alter the form of this product into a gas, powder or liquid through burning, crushing or chemical processing.
- Observe laws and company regulations when discarding this product.